IPC ASSOCIATION C	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1					Form Type Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information					
Supplier 1	Information															
Company name*			Company unique ID			Ţ	Unique ID Authority					Response Date*				
onsemi											2025-06-08					
Contact Nai	me	Title - Contact			1	Phone - Contact*					Email - Contact*					
Product-En	nv-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Authorized Representative*			Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
1	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective D	fective Date Version Manu		Manufa	Manufacturing Site		Weight*	UOM	Unit 7	гуре
		NVMTS0D7N04CTX T6 40V SG NCh				2025-06-08	:	PBB			319.28	mg	Each			
Manufact	turing Proccess Informati	on														
Т	Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 MS		L Rating	Peak Process Body Tempera		ature Ma	ture Max Time at Peak Tempo		ure Nu	mber of Reflow	Cycles		
Matte Tin (Sn) - annealed C		CU Alloy 1			260	260 C		30		secon	ids 3					
Comments																
evel 1 - max	ximum time at peak temperatur	e during sol	dering is 10-3	0 seconds												
or more in	formation regarding material co	omposition j	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions o											
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	-En									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	86.1	mg	Supplier	Zinc (Zn)	7440-66-6		0.1033	mg
			Supplier	Iron (Fe)	7439-89-6		2.0234	mg
			Supplier	Copper (Cu)	7440-50-8		83.9475	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0258	mg
Die	6.27	mg	Supplier	Silicon (Si)	7440-21-3		6.27	mg
Die Attach Solder	15.3	mg	Supplier	Silver (Ag)	7440-22-4		0.3825	mg
			A	Lead (Pb)	7439-92-1	7a	14.1525	mg
			Supplier	Tin (Sn)	7440-31-5		0.765	mg
Lead Frame	103.2	mg	Supplier	Silver (Ag)	7440-22-4		0.0826	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1238	mg
			Supplier	Iron (Fe)	7439-89-6		2.4252	mg
			Supplier	Copper (Cu)	7440-50-8		100.5374	mg
			Supplier	Phosphorus (P)	7723-14-0		0.031	mg
Mold Compound-Black	103.88			Epoxy resin	proprietary data		5.194	mg
			Supplier	Phenolic Resin	Proprietary Data		2.3892	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		5.194	mg
			Supplier	Carbon Black (C)	1333-86-4		0.4155	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		2.3892	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		88.298	mg
Plating	4.48	mg	Supplier	Tin (Sn)	7440-31-5		4.48	mg
Wire Bond - Cu	0.05	mg	Supplier	Copper (Cu)	7440-50-8		0.05	mg